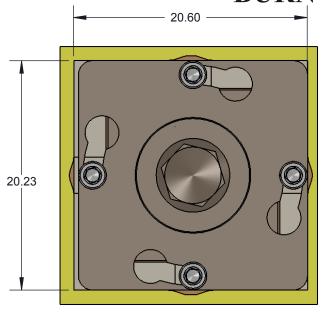
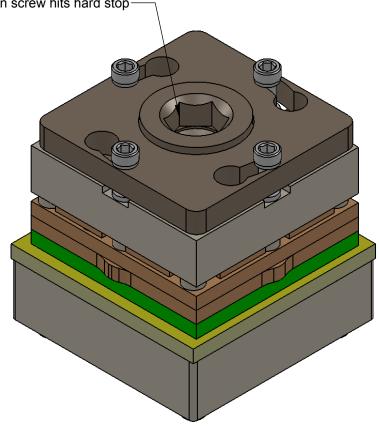
## SBT-BGA DIRECT MOUNT, SOLDERLESS SOCKET FOR **BURN-IN AND TEST APPLICATIONS**

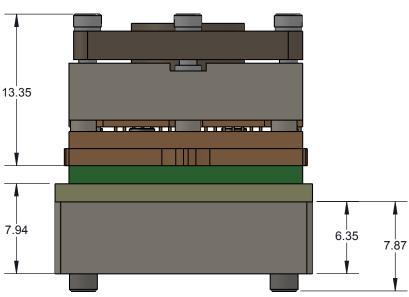


#### **Features**

- Wide temperature range (-55C to +180C)
- High current capability (up to 4A)
- Excellent signal integrity at high frequencies
  Low and stable contact resistance for reliable production yield
- Highly compliant to accommodate wide co-planarity variations
- Automated probe manufacturing enables low cost and short lead time

Tighten until compression screw hits hard stop





#### Description: SBT-BGA Socket, 15 X 15, 0.8mm, 17 X 17 Array

Primary dimension units are millimeters, Secondary dimension units are [inches], Weight is in grams.

Tolerances: Hole diameters ±0.03mm [±0.001"], Pitches (from true position) ±0.025mm [±0.001"], substrate thickness tolerance ±10%, all other tolerances ±0.13mm [±0.005"] unless stated otherwise. Materials and specifications are subject to change without notice

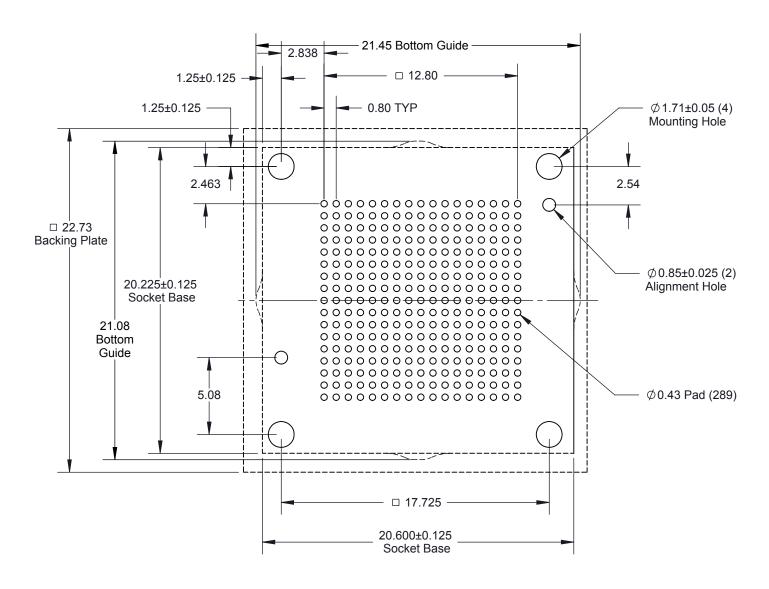
| SBT-BG | 4-6502 | Drawing |  |
|--------|--------|---------|--|
|        |        |         |  |



Ironwood Electronics, Inc. Tele: (800) 404-0204 www.ironwoodélectronics.com Material: ERROR!:Material Finish: ERROR!:Finish Weight: 21.18

| STATUS: Released       | SHEET: 1 OF 5      | REV. E     |
|------------------------|--------------------|------------|
| ENG: S. Faiz           | DRAWN BY: M. Raske | SCALE: 3:1 |
| FILE: SBT-BGA-6502 Dwg | DATE: 03/29/2011   |            |

# \*Note: BGA pattern is not symmetrical with respect to the mounting holes.



#### Description: SBT-BGA Socket, 15 X 15, 0.8mm, 17 X 17 Array

Primary dimension units are millimeters, Secondary dimension units are [inches], Weight is in grams.

Tolerances: Hole diameters ±0.03mm [±0.001"], Pitches (from true position) ±0.025mm [±0.001"], substrate thickness tolerance ±10%, all other tolerances ±0.13mm [±0.005"] unless stated otherwise. Materials and specifications are subject to change without notice.

Target PCB Recommendations Total thickness: 1.6mm min. Plating: Gold or Solder finish

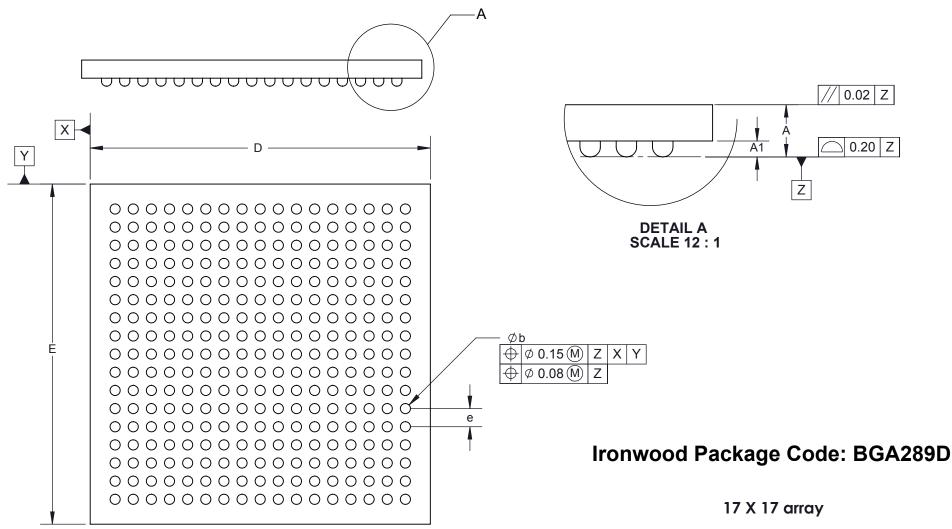
PCB Pad height: Same or higher than solder mask

#### SBT-BGA-6502 Drawing



Ironwood Electronics, Inc. Tele: (800) 404-0204 www.ironwoodelectronics.com Material: ERROR!:Material Finish: ERROR!:Finish Weight: 21.18

| STATUS: Released       | SHEET: 2 OF 5      | REV. E     |
|------------------------|--------------------|------------|
| ENG: S. Faiz           | DRAWN BY: M. Raske | SCALE: 4:1 |
| FILE: SBT-BGA-6502 Dwg | DATE: 03/29/2011   |            |



- Dimensions are in millimeters.
- 2. Interpret dimensions and tolerances per ASME Y14.5M-1994.
- 3. Dimension b is measured at the maximum solder ball diameter, parallel to datum plane Z.
- 4. Datum Z (seating plane) is defined by the spherical crowns of the solder balls.
- Parallelism measurement shall exclude any effect of mark on top surface of package.

|     |          | •       |  |
|-----|----------|---------|--|
| DIM | Minimum  | Maximum |  |
| Α   |          | 2.5     |  |
| A1  | 0.2      | 0.34    |  |
| b   |          | 0.45    |  |
| D   | 15.0 BSC |         |  |
| Е   | 15.0 BSC |         |  |
| е   | 0.80 BSC |         |  |

#### Description: SBT-BGA Socket, 15 X 15, 0.8mm, 17 X 17 Array

Primary dimension units are millimeters, Secondary dimension units are [inches], Weight is in grams.

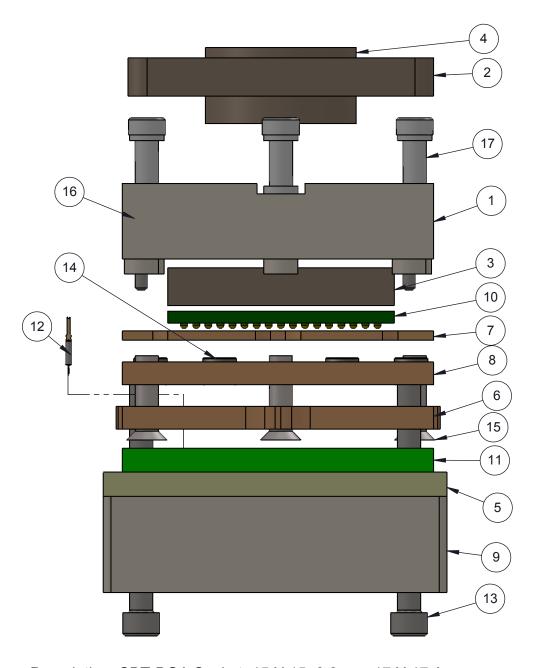
<u>Tolerances:</u> Hole diameters ±0.03mm [±0.001"], Pitches (from true position) ±0.025mm [±0.001"], substrate thickness tolerance ±10%, all other tolerances ±0.13mm [±0.005"] unless stated otherwise. Materials and specifications are subject to change without notice.

| SBT-BGA-6502 | <b>Drawing</b> |
|--------------|----------------|
|--------------|----------------|

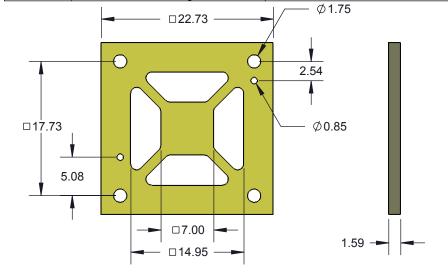


Material: ERROR!:Material Finish: ERROR!:Finish Weight: 21.18

| STATUS: Released       | SHEET: 3 OF 5      | REV. E     |
|------------------------|--------------------|------------|
| ENG: S. Faiz           | DRAWN BY: M. Raske | SCALE: 2:1 |
| FILE: SBT-BGA-6502 Dwg | DATE: 03/29/2011   |            |



| ITEM NO. | DESCRIPTION   | Material               |
|----------|---|------------------------|
| 1        | Socket Base SBT BGA 15x15mm<br>0.375 SFT  | 7075-T6 Aluminum Alloy |
| 2        | Socket Lid, 15mm  | 7075-T6 Alumium Alloy  |
| 3        | Compression Plate, 15mm x 15mm  | 7075-T6 Aluminum Alloy |
| 4        | Compression Screw M10   | 7075-T6 Alumium Alloy  |
| 5        | Insulation Plate  | FR4                    |
| 6        | Bottom Guide BGA289, 15mm,<br>0.8mm pitch, 17x17 array                            | Semitron MDS 100       |
| 7        | Floating Guide 15mmsq. 0.8mm<br>17x17array  | Semitron MDS 100       |
| 8        | Middle Pogo Guide 15mm 0.8mm<br>17x17 array                                       | Semitron MDS 100       |
| 9        | SBT/CBT Ni Plated 15mm Backing Plate  | 7075-T6 Alumium Alloy  |
| 10       | BGA196 ,0.8mm Pitch   | FR4                    |
| 11       | Target PCB BGA289 17x17array<br>15mmx15mm 0.8mm pitch                             | FR4 High temp          |
| 12       | SBT Pin, SBT-BGA 0.5mm-0.8mm  |                        |
| 13       | #0-80 X .625 LG, SOC HD CAP<br>SCREW, ALLOY STL, BLK OXIDE                        | Alloy Steel            |
| 14       | Floating Guide Spring   | Alloy Steel (SS)       |
| 15       | #0-80, 90 deg., head pin guide<br>screw, Peek material 5.5715mm<br>overall Length | PEEK unfilled          |
| 16       | Dowel pin, 1/32" X 1/4", SS   | Stainless Steel (18-8) |
| 17       | #0-80 Shoulder Screw, 0.062"<br>thread length                                     | Stainless Steel (303)  |



### Description: SBT-BGA Socket, 15 X 15, 0.8mm, 17 X 17 Array

Primary dimension units are millimeters, Secondary dimension units are [inches], Weight is in grams.

Tolerances: Hole diameters +0.03mm [+0.001"]. Pitches (from true position) +0.025mm [+0.001"] subs

Tolerances: Hole diameters ±0.03mm [±0.001"], Pitches (from true position) ±0.025mm [±0.001"], substrate thickness tolerance ±10%, all other tolerances ±0.13mm [±0.005"] unless stated otherwise. Materials and specifications are subject to change without notice.

#### SBT-BGA-6502 Drawing



Ironwood Electronics, Inc. Tele: (800) 404-0204 www.ironwoodelectronics.com Material: ERROR!:Material Finish: ERROR!:Finish Weight: 21.18

| STATUS: Released       | SHEET: 4 OF 5      | REV. E     |
|------------------------|--------------------|------------|
| ENG: S. Faiz           | DRAWN BY: M. Raske | SCALE: 3:1 |
| FILE: SBT-BGA-6502 Dwg | DATE: 03/29/2011   |            |

#### **INSULATION PLATE DETAIL**

| Rev | Date     | Initials | Description                            |
|-----|----------|----------|--|
| Α   | 3/29/11  | MR       | Original                               |
| В   | 4/19/13  | SF       | Revised Compression screw.             |
| С   | 9/24/13  | GL       | Added feet (1mm bosses) to Socket Base |
| D   | 02/19/14 | DH       | Changed current rating of pin          |
| Е   | 03/04/15 | RP/MR    | P-P196A was P-P149A, R3200 was R1391   |

#### **Description: Revision History**

 $\label{thm:condition} \mbox{Primary dimension units are [inches], Weight is in grams.}$ 

Tolerances: Hole diameters ±0.03mm [±0.001"], Pitches (from true position) ±0.025mm [±0.001"], substrate thickness tolerance ±10%, all other tolerances ±0.13mm [±0.005"] unless stated otherwise. Materials and specifications are subject to change without notice.

| SBT-BGA-6502 Drawing                            | Material: Finish: Weight: | STATUS: Released       | SHEET: 5 OF 5      | REV. E     |
|---|---------------------------|------------------------|--------------------|------------|
| Ironwood Electronics, Inc. Tele: (800) 404-0204 |                           | ENG: S. Faiz           | DRAWN BY: M. Raske | SCALE: 3:1 |
| www.ironwoodelectronics.com                     | woight.                   | FILE: SBT-BGA-6502 Dwg | DATE: 03/29/2011   |            |